

4/20/05

Form PTO-1595 (Rev. 10/02) REC: OMB No. 0651-0027 (exp. 6/30/2005) Tab settings

06-28-2005

U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

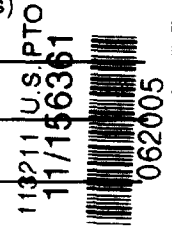


103029800

To the Honorable Commissioner of Patents original documents or copy thereof.

1. Name of conveying party(ies): Chun-Tiao Liu Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies) Name: CYNTEC COMPANY Internal Address: Street Address: 4 Innovative 1st Road Science-Based Industrial Park City: Hsinchu, Taiwan, R.O.C. State: Zip: Additional name(s) & address(es) attached? Yes No



3. Nature of conveyance: [X] Assignment [ ] Merger [ ] Security Agreement [ ] Change of Name [ ] Other Execution Date: June 6, 2005

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: June 6, 2005 A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed: Name: Bo-In Lin Internal Address: Street Address: 13445 Mandoli Drive City: Los Altos Hills, CA State: CA Zip: 94022

6. Total number of applications and patents involved: 7 Total fee (37 CFR 3.41): \$ 40.00 [X] Enclosed [ ] Authorized to be charged to deposit account 8. Deposit account number: (Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Ching-lu Lin Name of Person Signing Signature June 18, 2006 Date Total number of pages including cover sheet, attachments, and documents: 2

06/27/2005 DBYRNE 01 FC:8021

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

PATENT REEL: 016714 FRAME: 0709

ASSIGNMENT

INVENTOR  
AND CITY

Whereas, I, Chu-Tiao Liu of No.19, 6F Industrial Park First Road,  
Science-Based Industrial Park, Hsinchu, Taiwan, Republic of China,

have invented:

Title: **CURRENT MEASUREMENT USING INDUCTOR COIL WITH COMPACT CONFIGURATION  
AND LOW TCR ALLOYS**

DATE INVENTOR  
SIGNED THE  
DECLARATION

and executed a United States patent application therefor

on June 6 2005;

Whereas, **CYNTEC COMPANY**, having a place of business at **Hsinchu, Taiwan, Republic of China**, (hereinafter called **CYNTEC**), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to **CYNTEC**, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to **CYNTEC** its successors and assigns; and I hereby agree that **CYNTEC** may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND  
DATE

Signed and Sealed at: Hsinchu, Taiwan, ROC

on June 6 2005.

Chu-Tiao Liu

SIGNATURE OF INVENTOR